

*a /
Amend'd*

adding a second conduction powder that has lower conductivity than said first conduction powder to said lower step so that a surface of said second conduction powder can be flush with a surface of said first conduction powder thereby forming a layer of said second conduction powder having a thickness that corresponds to a difference between said higher step and said lower step;

pressing and hardening said first and second conduction powders by a single punch to form a mold; and

sintering said mold,

wherein said step of filling said first conduction powder comprises a step of filling said first conduction powder flat into said female die and a step of scraping a surface portion of said first conduction powder by a movable member to form said step.--

--10. The method as claimed in claim 9, wherein said pressing and hardening step further comprises a step of inserting a male die that holds a pigtail at its end into said first conduction powder.--

--11. The method as claimed in claim 10, wherein at least a half of said pigtail is embedded in said first conduction powder.--

REMARKS

Claims 9-11 are pending. By this Amendment claims 1-8 are canceled without prejudice or disclaimer and claims 9-11 are added. Support for claims 9-11 may be found throughout the specification and at least at page 11, line 10 - page 12, line 15. Thus, no new matter is added.

The Office Action requests amendment to the specification due to the incorporation of a foreign application by reference. Reference to the foreign application is deleted.

The Office Action rejects claims 1-8 under 35 U.S.C. §112, first paragraph, and second paragraph. As claims 1-8 are canceled, the rejections are moot.